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N-Channel PowerTrench[®] SyncFETTM **30 V, 49 A, 2.8 m**Ω

Features

- Max $r_{DS(on)} = 2.8 \text{ m}\Omega \text{ at } V_{GS} = 10 \text{ V}, I_D = 24 \text{ A}$
- Max $r_{DS(on)} = 3.5 \text{ m}\Omega \text{ at } V_{GS} = 4.5 \text{ V}, I_D = 21 \text{ A}$
- Advanced package and silicon combination for low r_{DS(on)} and high efficiency
- SyncFET Schottky Body Diode
- MSL1 robust package design
- 100% UIL tested
- RoHS Compliant

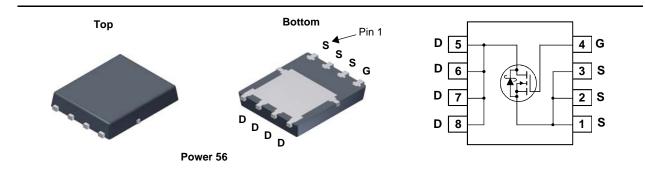


General Description

The FDMS0308AS has been designed to minimize losses in power conversion application. Advancements in both silicon and package technologies have been combined to offer the lowest r_{DS(on)} while maintaining excellent switching performance.This device has the added benefit of an efficient monolithic Schottky body diode.

Applications

- Synchronous Rectifier for DC/DC Converters
- Notebook Vcore/GPU low side switch
- Networking Point of Load low side switch
- Telecom secondary side rectification



MOSFET Maximum Ratings T_C = 25°C unless otherwise noted

| Symbol | Parameter | | | Ratings | Units | |
|-----------------------------------|--|-----------------------|-----------|-------------|-------|--|
| V _{DS} | Drain to Source Voltage | | | 30 | V | |
| V _{GS} | Gate to Source Voltage | | | ±20 | V | |
| ID | Drain Current -Continuous (Package limited) | T _C = 25°C | | 49 | A | |
| | -Continuous (Silicon limited) | T _C = 25°C | | 109 | | |
| | -Continuous | $T_A = 25^{\circ}C$ | (Note 1a) | 24 | | |
| | -Pulsed | | | 100 | | |
| E _{AS} | Single Pulse Avalanche Energy | | (Note 3) | 66 | mJ | |
| P _D | Power Dissipation | T _C = 25°C | | 50 | | |
| | Power Dissipation | $T_A = 25^{\circ}C$ | (Note 1a) | 2.5 | | |
| T _J , T _{STG} | Operating and Storage Junction Temperature Range | | | -55 to +150 | °C | |

Thermal Characteristics

FDMS0308AS Rev.C2

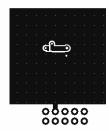
| $R_{	ext{	heta}JC}$ | Thermal Resistance, Junction to Case | 2.5 | °C/W |
|---------------------|--|-------|------|
| R_{\thetaJA} | Thermal Resistance, Junction to Ambient (Note 1a | l) 50 | 0/11 |

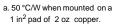
Package Marking and Ordering Information

| Device Marking | Device | Package | Reel Size | Tape Width | Quantity |
|----------------|------------|----------|-----------|------------|------------|
| FDMS0308AS | FDMS0308AS | Power 56 | 13 " | 12 mm | 3000 units |

October 2014

| Symbol | Parameter | Test Conditions | Min | Тур | Max | Units | |
|--|--|---|-----|--------------------|------|----------|--|
| Off Chara | acteristics | | | | | | |
| BV _{DSS} | Drain to Source Breakdown Voltage | I _D = 1 mA, V _{GS} = 0 V | 30 | | | V | |
| ∆BV _{DSS} | Breakdown Voltage Temperature | | 00 | | | - | |
| ΔT_{J} | Coefficient | $I_D = 10$ mA, referenced to 25°C | | 19 | | mV/°C | |
| I _{DSS} | Zero Gate Voltage Drain Current | $V_{DS} = 24 V, V_{GS} = 0 V$ | | | 500 | μA | |
| I _{GSS} | Gate to Source Leakage Current, Forward | $V_{GS} = 20 \text{ V}, V_{DS} = 0 \text{ V}$ | | | 100 | nA | |
| On Chara | acteristics | | | | | | |
| V _{GS(th)} | Gate to Source Threshold Voltage | $V_{GS} = V_{DS}$, $I_D = 1 \text{ mA}$ | 1.2 | 1.7 | 3.0 | V | |
| $\frac{\Delta V_{GS(th)}}{\Delta T_{I}}$ | Gate to Source Threshold Voltage Temperature Coefficient | $I_D = 10$ mA, referenced to 25°C | | -5 | | mV/°C | |
| 0 | | V _{GS} = 10 V, I _D = 24 A | | 2.2 | 2.8 | | |
| r _{DS(on)} | Static Drain to Source On Resistance | $V_{GS} = 4.5 \text{ V}, I_D = 21 \text{ A}$ | | 3.0 | 3.5 | mΩ | |
| - (-) | | $V_{GS} = 10 \text{ V}, \text{ I}_{D} = 24 \text{ A}, \text{ T}_{J} = 125^{\circ}\text{C}$ | | 3.1 | 4.0 | - | |
| Ĵfs | Forward Transconductance | $V_{DS} = 5 V, I_{D} = 24 A$ | | 145 | | S | |
| C _{iss} | Characteristics Input Capacitance | V _{DS} = 15 V, V _{GS} = 0 V, | | 2255 | 3000 | pF | |
| C _{oss} | Output Capacitance | f = 1MHz | | 815 | 1085 | pF | |
| C _{rss} | Reverse Transfer Capacitance | | | 85 | 125 | pF | |
| R _g | Gate Resistance | | | 1.0 | 2.5 | Ω | |
| Switching | g Characteristics | | | | | | |
| t _{d(on)} | Turn-On Delay Time | | | 11 | 19 | ns | |
| | Rise Time | V _{DD} = 15 V, I _D = 24 A, | | 4.5 | 10 | ns | |
| r | Turn-Off Delay Time | V_{GS} = 10 V, R_{GEN} = 6 Ω | | 29 | 46 | ns | |
| | | | | 3.7 | 10 | ns | |
| d(off) | Fall Time | | | 34 | 47 | nC | |
| d(off) f | | $V_{GS} = 0$ V to 10 V | | | | nC | |
| d(off) f Qg | Fall Time | | | 16 | 23 | | |
| ^t d(off) Q _g Q _g Q _{gs} | Fall Time Total Gate Charge Total Gate Charge Gate to Source Charge | | | 16 5.9 | 23 | nC | |
| d(off) f Q _g Q _g | Fall Time Total Gate Charge Total Gate Charge | | | - | 23 | nC nC | |
| id(off) Qg Qg Qgs Qgs Qgd | Fall Time Total Gate Charge Total Gate Charge Gate to Source Charge | | | 5.9 | 23 | _ | |
| id _(off) if Q _g Q _g Q _{gs} Q _{gd} Drain-So | Fall Time Total Gate Charge Total Gate Charge Gate to Source Charge Gate to Drain "Miller" Charge urce Diode Characteristics | | | 5.9 | 0.8 | nC | |
| id _(off) if Q _g Q _g Q _{gs} Q _{gd} Drain-So | Fall TimeTotal Gate ChargeTotal Gate ChargeGate to Source ChargeGate to Drain "Miller" Charge | $V_{GS} = 0 V \text{ to } 4.5 V$ $V_{DD} = 15 V$, $I_D = 24 A$ | | 5.9 4.6 | | _ | |
| t _r t _{d(off)} t _f Q _g Q _{gs} Q _{gd} Drain-So V _{SD} t _{rr} | Fall Time Total Gate Charge Total Gate Charge Gate to Source Charge Gate to Drain "Miller" Charge urce Diode Characteristics | $V_{GS} = 0 \text{ V to } 4.5 \text{ V}$ $V_{DD} = 15 \text{ V},$ $I_D = 24 \text{ A}$ $V_{GS} = 0 \text{ V}, I_S = 2 \text{ A}$ (Note 2) | | 5.9 4.6 0.62 | 0.8 | nC | |







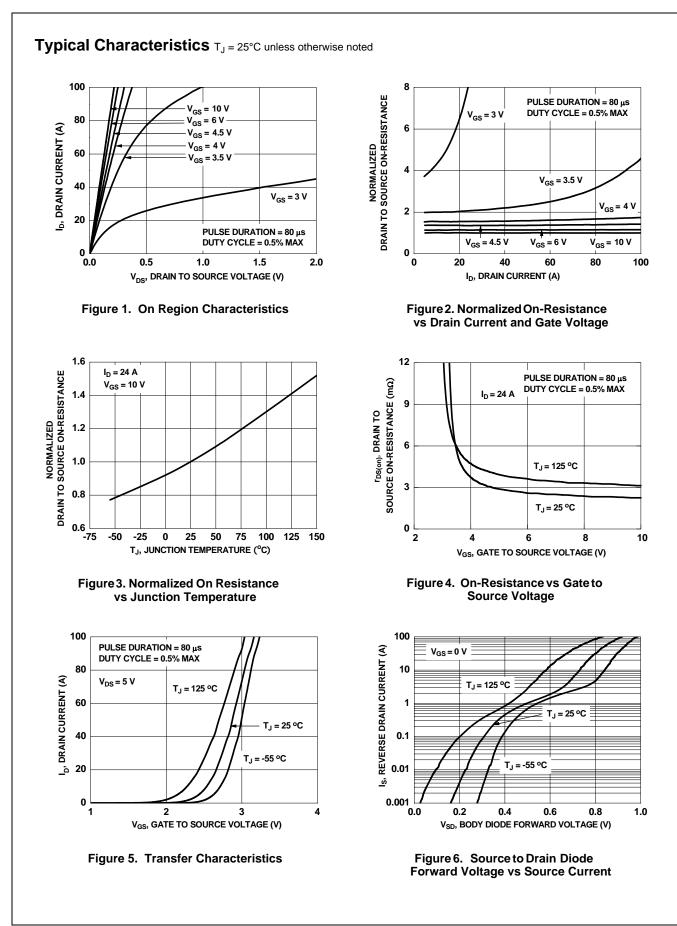
b. 125 °C/W when mounted on a minimum pad of 2 oz copper.

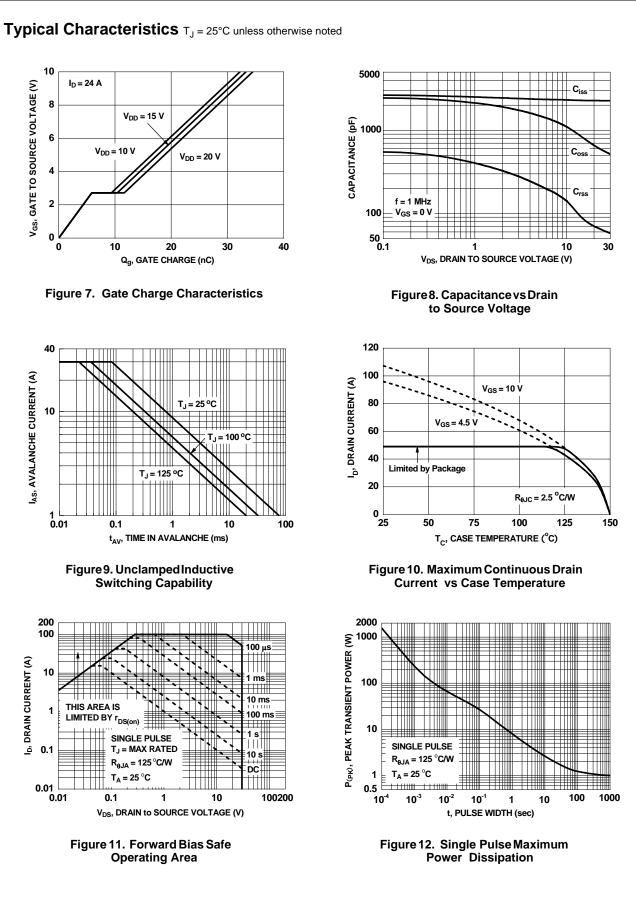


2. Pulse Test: Pulse Width < 300 $\mu s,$ Duty cycle < 2.0%.

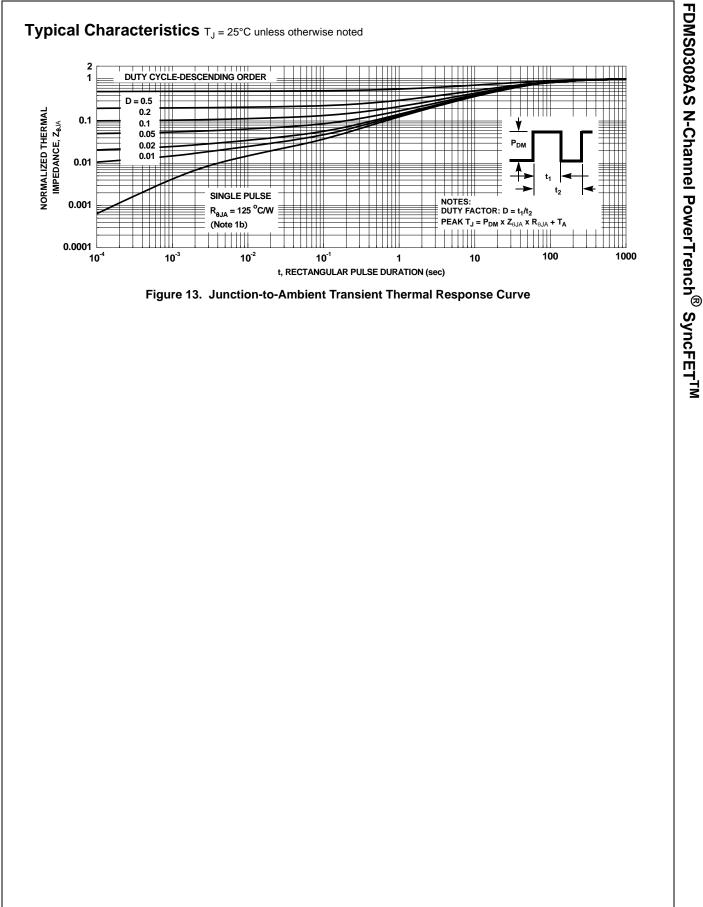
3. E_{AS} of 66 mJ is based on starting T_{J} = 25 °C, L = 0.3 mH, I_{AS} = 21 A, V_{DD} = 27 V, V_{GS} = 10 V.

4. As an N-ch device, the negative Vgs rating is for low duty cycle pulse occurrence only. No continuous rating is implied.





4



FDMS0308AS N-Channel PowerTrench[®] SyncFETTM

Typical Characteristics (continued)

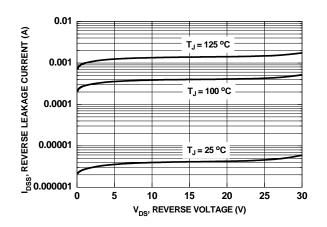
SyncFET Schottky body diode Characteristics

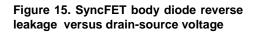
Fairchild's SyncFET process embeds a Schottky diode in parallel with PowerTrench MOSFET. This diode exhibits similar characteristics to a discrete external Schottky diode in parallel with a MOSFET. Figure 14 shows the reverses recovery characteristic of the FDMS0308AS.

25 20 15 CURRENT (A) 10 di/dt = 300 A/µs 5 0 -5 0 50 100 200 250 150 TIME (ns)

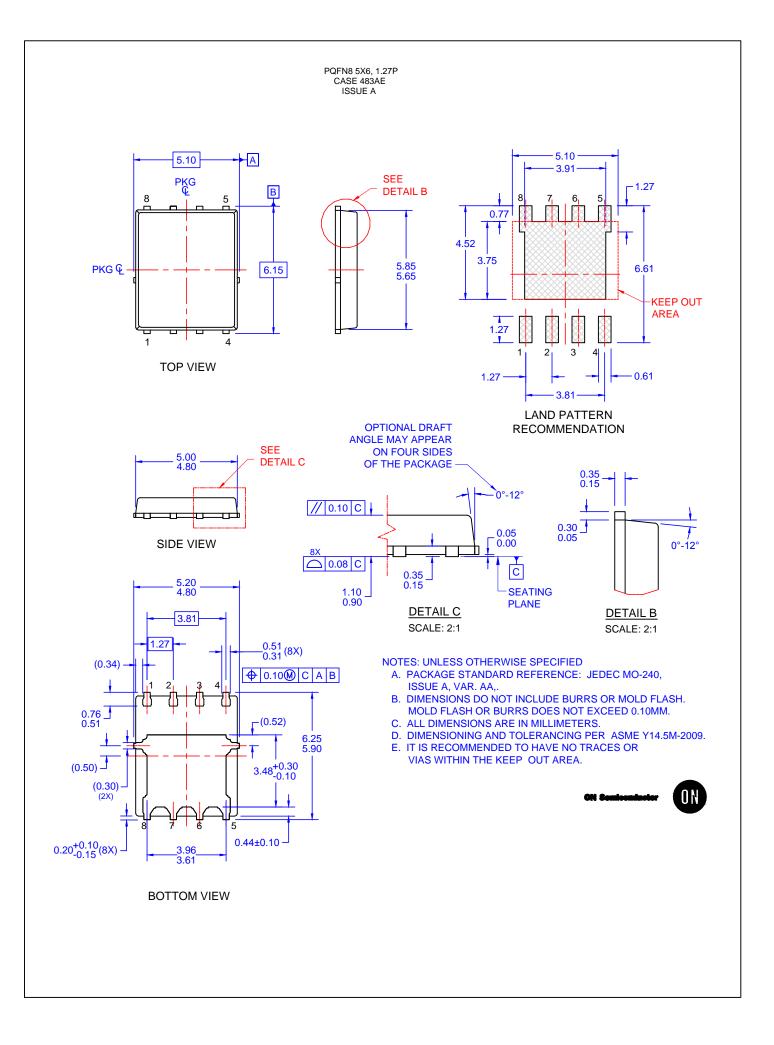
Figure 14. FDMS0308AS SyncFET body diode reverse recovery characteristic

Schottky barrier diodes exhibit significant leakage at high temperature and high reverse voltage. This will increase the power in the device.





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